

IN THE UNITED STATES PATENT AND TRADEM

priorityApplication Serial No.09/036,701priorityFiling DateMarch 6, 1998
Inventor
Assignee Micron Technology, Inc.
priority Group Art Unit
priority Examiner H. Tsai
Attorney's Docket No. MI22-1243
Title: Semiconductor Processing Methods of Forming Devices on a Substrate,
Forming Device Arrays on a Substrate, Forming Conductive Lines on a
Substrate, and Forming Capacitor Arrays on a Substrate, and Integrated

PRELIMINARY AMENDMENT

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BOX PATENT APPLICATION

Assistant Commissioner for Patents

Washington, D.C. 20231

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<u>AMENDMENTS</u>

In the Specification

Circuitry

At p. 1 before the "Technical Field" section, please insert the following:

--RELATED PATENT DATA

This patent resulted from a divisional application of U.S. Patent US Pat. NO. 6, 48c Application Serial No. 09/036,701, filed March 6, 1998, which is a

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